

Preliminary specification

Specification

CA6868

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문서명 : 제품개발(UV PKG) 절차서



CA6868

Description

High power UV LED series are designed for high current operation and high power output applications. It incorporates state of the art SMD design and low thermal resistant material.

CA6868 NUV LED is ideal UV light source for curing, printing, and detecting applications.

CA6868

Features

- Super high power output
- Designed for high current operation
- Low thermal resistance
- SMT solderable
- Lead Free product
- RoHS compliant

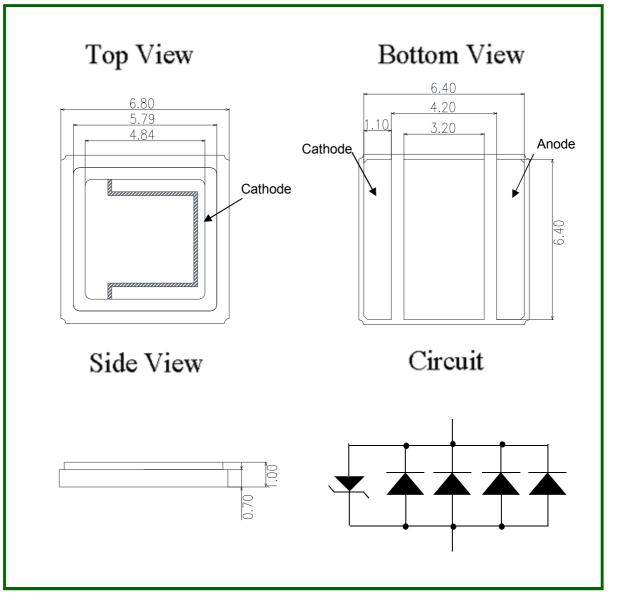
Applications

- UV Curing
- Printing
- Coating
- Adhesive
- Counterfeit Detection/ Security
- UV Torch
- Fluorescence Photography
- Dental Curing
- Crime Inspection
- Oil leak Detection

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Notes :

- [1] All dimensions are in millimeters.
- [2] Scale : none
- [3] Undefined tolerance is ± 0.2 mm

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Characteristics of CA6868

1 Electro-Optical characteristics at 4A

(T_a=25℃, RH=30%)

Parameter	Symbol	Value	Unit
Peak wavelength [1]	$\lambda_{ m p}$	365	nm
Radiant Flux ^[2]	$\Phi_{e}^{[3]}$	5000	mW
Forward Voltage ^[4]	V _F	4.1	V
Spectrum Half Width	Δλ	9.5	nm
View Angle	2Θ _{1/2}	-	deg.
Thermal Resistance	R _{⊖ j-b}	_	°C/W

2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I _F	-	А
Junction Temperature	Tj	125	٥C
Operating Temperature	T _{opr}	-10 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C

Notes :

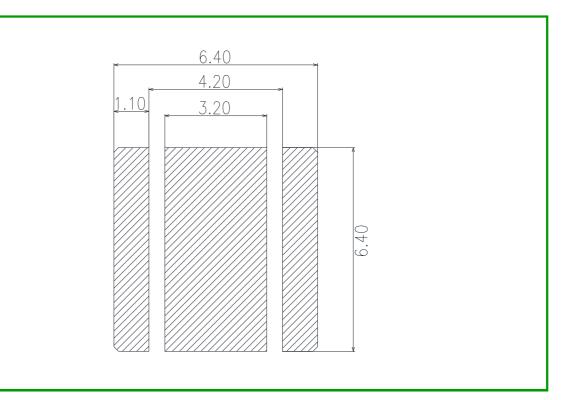
- 1. Peak Wavelength Measurement tolerance : $\pm 3 \text{nm}$
- 2. Radiant Flux Measurement tolerance : \pm 10%
- 3. Φ_{e} is the Total Radiant Flux as measured with an integrated sphere.
- 4. Forward Voltage Measurement tolerance : $\pm 3\%$
- 5. $R_{\theta_{J-b}}$ is the thermal resistance between chip junction to PCB board bottom. The PCB is made of aluminium and the size of PCB is 3.5cm by 3.5cm

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Recommended solder pad



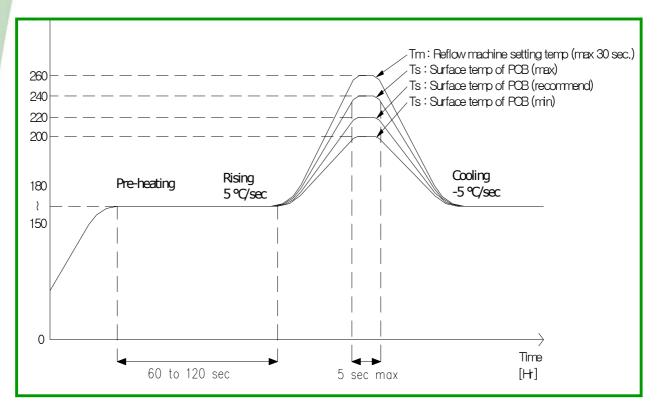
Notes :

- [1] All dimensions are in millimeters.
- [2] Scale : none[3] This drawing without tolerances is for reference only

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Reflow Soldering Profile



* Caution

- 1. Reflow soldering should not be done more than one time.
- 2. Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- 3. Die slug is to be soldered.
- 4. When soldering, do not put stress on the LEDs during heating.
- 5. After soldering, do not warp the circuit board.
- 6. Recommend to use a convection type reflow machine with 7 ~ 8 zones.

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Precaution for use

1) Storage

- To avoid moisture penetration, we recommend storing UV LEDs in a dry box with a desiccant. The recommended temperature and Relative humidity are between 5°C and 30°C and below 50% respectively.
- LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from SVC, a sealed container with a nitrogen atmosphere should be used for storage.
- Replace the remained LEDs into the moisture-proof bag and reseal the bag after work to avoid those LEDs being exposed to moisture. Prolonged exposure to moisture can adversely affect the proper functioning of the LEDs.
- If the package has been opened more than 4 week(MSL_2a) or the color of the desiccant changes, components should be dried for 10-12hr at $60\pm5\,^\circ$ C
- The conditions of resealing are as follows
 - Temperature is 5 to 40° C and Relative humidity is less than 30%
- 2) Handling Precautions
 - VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate window parts of LEDs and discolor them when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
 - In case of attaching LEDs, do not use adhesives that outgas organic vapor.
 - Soldering should be done as soon as possible after opening the moisture-proof bag.
 - Do not rapidly cool device after soldering.
 - Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
 - Components should not be mounted on warped (non coplanar) portion of PCB.
 - The optical window part of LED needs to be handled carefully as below
 - Avoid touching the optical window especially with sharp tools such as Pincettes (Tweezers)
 - Avoid leaving fingerprints on optical window parts.
 - Optical window will attract dust so use covered containers for storage.
 - When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that excessive mechanical pressure on the surface of optical window parts must be prevented.
 - It is not recommend to cover the optical window of the LEDs with other resin (epoxy, urethane, etc)



- 3) Safety for eyes and skin
 - The Products emit high intensity ultraviolet light which can make your eyes and skin harmful, So do not look directly into the UV light and wear protective equipment during operation.

4) Cleaning

• This device is not allowed to be used in any type of fluid such as water, oil, organic solvent , etc.

5) Others

- The appearance and specifications of the product may be modified for improvement without notice.
- When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.
- Do not handle this product with acid or sulfur material in sealed space.



\rm CAUTION

•UV LEDs emit high intensity UV light. •Do not look directly into the UV light during operation. This can be harmful to your eyes and skin.

•Wear protective eyewear to avoid exposure to UV light. •Attach caution labels to your products which contain UV LEDs.

Avoid direct eye and skin exposure to UV light. Keep out of reach of children.

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Revision history

REV	Change Date	Brief summary of change
-	March 10, 2015	preliminary specification



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